4AK15

Silicon N-Channel Power MOS FET Array

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Application

High speed power switching

Features

- Low on-resistance
 - $R_{\rm DS(on)} \quad 0.07 \quad \text{, } V_{\rm GS} = 10 \ \text{V} \text{, } I_{\rm D} = 8 \ \text{A}$

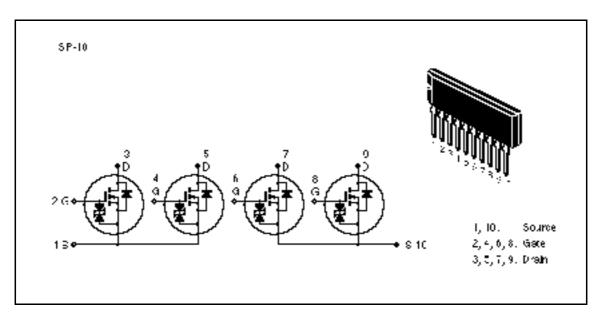
 $R_{\rm DS(on)} \quad 0.095 \quad \text{, } V_{\rm GS} = 4 \ V \text{, } I_{\rm D} = 8 \ A$

- Capable of 4 V gate drive
- Low drive current
- High speed switching
- High density mounting
- Suitable for motor driver, solenoid driver and lamp driver
- Discrete packaged devices of same die: 2SK971, 2SK1094



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Outline



Absolute Maximum Ratings (Ta = 25°C) (1 Unit)

Item	Symbol	Rating	Unit
Drain to source voltage	V _{DSS}	±60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	8	А
Drain peak current	L(pulse) * 1	32	A
Body to drain diode reverse drain current	I _{DR}	8	А
Channel dissipation	Pch (Tc = 25°C)*2	28	W
Channel dissipation	Pch* ²	4	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Notes: 1. PW 10 µs, duty cycle 1%

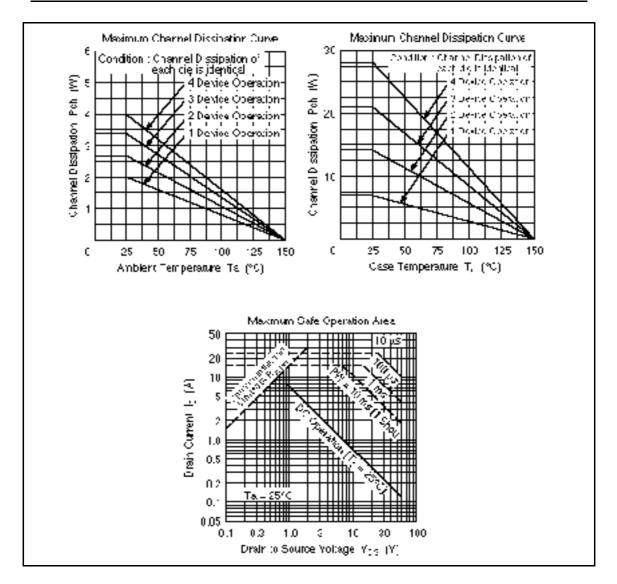
2. 4 devices operation

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{\rm (BR)DSS}$	60	_	_	V	$I_{\rm D} = 10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	±20	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	250	μA	$V_{\rm DS} = 50 \text{V}, V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	1.0	_	2.0	V	$I_{\rm D} = 1 \text{ mA}, V_{\rm DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{\text{DS(on)}}$	_	0.055	0.07		$I_{D} = 8 \text{ A}$ $V_{GS} = 10 \text{ V}^{*1}$
		_	0.075	0.095		$I_{D} = 8 A$ $V_{GS} = 4 V^{*1}$
Forward transfer admittance	y _{fs}	7	12	_	S	$I_{D} = 8 A$ $V_{DS} = 10 V^{*1}$
Input capacitance	Ciss	_	860	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	450	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	140	_	pF	f = 1 MHz
Turn-on delay time	t _{d(on)}	_	10	_	ns	I _D = 8 A
Rise time	t,	_	70	_	ns	V _{GS} = 10 V
Turn-off delay time	$t_{d(off)}$	—	180	_	ns	$R_{L} = 3.75$
Fall time	t _f	—	120	—	ns	_
Body to drain diode forward voltage	V_{DF}	_	1.05	_	V	$I_{F} = 8 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}		110	_	ns	I _F = 8 A, V _{GS} = 0 dIF/dt = 50 A/μs

Electrical Characteristics (Ta = 25°C) (1 Unit)

Note: 1. Pulse test

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